



ABS10(LS) **GLASS PASSIVATED** REVERSE VOLTAGE – 1000 Volts SURFACE MOUNT BRIDGE RECTIFIER FORWARD CURRENT -1 Ampere **FEATURES** ABS Glass Passivated Chip Junction Reverse Voltage – 1000V ABS Forward Current – 1A DIM MIN MAX High Surge Current Capability Α 1.30 1.50 Designed for Surface Mount Application 0.15 0.22 С 5.20 D 4.90 UL recognized file#E364304 Е 4.20 4.50 • Lead-Free Finish; RoHS Compliant (Notes 1 & 2) ΗE 6.00 6.40 • Halogen and Antimony Free. "Green" Device 3.80 4.20 d (Note 3) 0.50 0.70 е L1 0.60 7° TYP. **MECHANICAL DATA** Ζ 7° TYP. Ζ Package Material: ABS All dimension in Package Material: Green molding compound, UL millimeter flammability classification 94V-0, (No Br. Sb. Cl.) • Terminals: Solderable per MIL-STD-750, Method 2026 Weight: 88 mg (Approximate) MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

ABSOLUTE RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	1000	V
Maximum DC blocking voltage	V _{DC}	1000	V
Average rectified output current per device	I _(AV)	1	А
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load @ T _A =25°C	I _{FSM}	30	А
I^2 t rating for fusing (t = 8.3ms)	I²t	3.75	A ² S
Operating and storage temperature range	T _J ,T _{STG}	-55 to +150	°C

STATIC ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward voltage	$I_F = 1A$ $T_A = 25^{\circ}C$	V _F	1.1	V
Leakage current	$V_{R} = 1000V \qquad \begin{array}{c} T_{A} = 25^{\circ}C \\ T_{A} = 125^{\circ}C \end{array}$	I _R	1 500	uA
Typical junction capacitance (Note	9 4)	CJ	13	pF

THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	TYP.	UNIT
Typical thermal resistance (Note 5)	RthJ _c RthJ _A	20 80	°C/W

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

5. Thermal resistance junction to case, lead and ambient in accordance with JESD-51.

Unit mounted on glass-epoxy PC board with 1.3mm₂ copper pad.

^{4.} Measured at 1.0MHz and applied reverse voltage of 4.0V DC.